

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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DA1206C121R-10

UNCONTROLLED **DOCUMENT**

PHYSICAL DIMENSIONS:

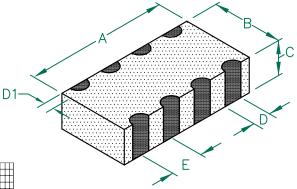


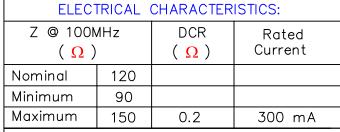
± 0.200 [.008] C 0.80 [.031]

± 0.150 [.006] D 0.40 [.016]

± 0.200 [.008] D1 0.30 [.012]

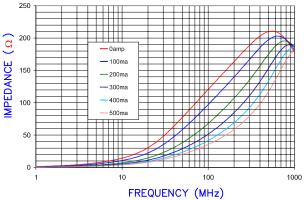
± 0.100 [.004] E 0.80 [.031]





LINE TO LINE INSULATION RESISTANCE >100 M Ω AT 75 VOLTS.

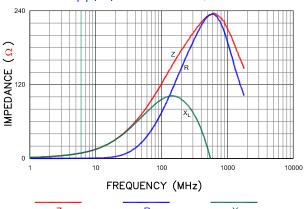
Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

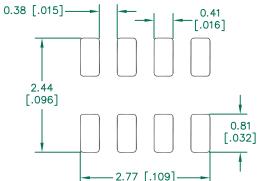


NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

|Z| , R, AND X vs. FREQUENCY

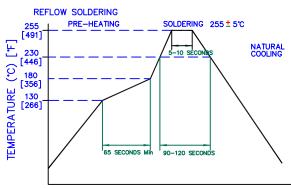




LAND PATTERNS FOR REFLOW SOLDERING

(For wave soldering, add 0.762 (0.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS



	DIMENSIONS ARE IN mm [INCHES].			
D	OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QI	
С	UPDATE COMPANY LOGO ADD ROHS	05/20/09	ß	
В	D1 dim chgd from 0.008 ±0.004 to 0.012 ± 0.008. UPDATE COMPANY LOGO	10/30/07	JR	
Α	ORIGINAL DRAFT	03/30/04	ТМ	
REV	DESCRIPTION	DATE	Z	

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PROJECT/PART NUMBER:

DA1206C121R-10

D CO-FIRE SHEET:

ТМВ

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DRAWN BY:

03/30/04 NTS DA1206C121R-10-D

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3124